

# QUICKSWITCH<sup>®</sup> PRODUCTS 2.5V / 3.3V 16-BIT HIGH BANDWIDTH BUS SWITCH

**DESCRIPTION:** 

high impedence at the terminals.

**A**4

A5 A6 A7

applications.

## IDTQS32XVH2245

The QS32XVH2245 HotSwitch is a high bandwidth, 16-bit bus switch. The

QS32XVH2245, with 25 $\Omega$  ON resistance and 1.35ns propagation delay, is

ideal for line matching and low noise environments. The switches can be turned

ON under the control of the LVTTL-compatible Output Enable (OEx) signal for

bidirectional data flow with no added delay or ground bounce. In the ON state,

the switches can pass signals up to 5V. In the OFF state, the switches offer very

The combination of small propagation delay, high OFF impedance, and

The QS32XVH2245 is characterized for operation from -40°C to +85°C.

over-voltage tolerance makes the QS32XVH2245 ideal for hot-swapping

## **FEATURES:**

- N channel FET switches with no parasitic diode to Vcc
  - Isolation under power-off conditions
  - No DC path to Vcc or GND
- 5V tolerant in OFF and ON state
- 5V tolerant I/Os
- Flat Row characteristics over operating range
- Rail-to-rail switching 0 5V
- Bidirectional dataflow with near-zero delay: no added ground bounce
- · Excellent Ron matching between channels
- Vcc operation: 2.3V to 3.6V
- · High bandwidth
- LVTTL-compatible control Inputs
- Undershoot Clamp Diodes on all switch and control Inputs
- · Low I/O capacitance, 4pF typical
- 25Ω resistors for low noise and line matching
- Available in 40-pin QVSOP package

## **APPLICATIONS:**

- · Hot-swapping
- · Low distortion analog switch
- Replaces mechanical relay
- ATM 25/155 switching

## **FUNCTIONAL BLOCK DIAGRAM**

### OF1 B0 B1 B2 Вз B4 B5 B6 B7 **A**8 **A**9 A10 A11 A12 A13 A14 A15 OF<sub>2</sub> B8 B9 B10 B11 B12 B13 B14 B15

A0 A1 A2 A3

### INDUSTRIAL TEMPERATURE RANGE

### **JUNE 2011**

#### 1

## **PIN CONFIGURATION**

	1		_		1	
NC	d	1	Ŭ	40	þ	Vcc
A0	Ц	2		39		OE1
A1	Ц	3		38		B0
A2	Ц	4		37		B1
A3	Ц	5		36		B2
A4	Ц	6		35		B3
<b>A</b> 5	Ц	7		34		B4
A6	Ц	8		33		B5
A7	Ц	9		32	þ	B6
GND	Ц	10		31		B7
NC	Ц	11		30	þ	Vcc
A8	Ц	12		29		OE2
A9	Ц	13		28	þ	B8
A10	Ц	14		27		B9
A11	Ц	15		26	þ	B10
A12	Ц	16		25		B11
A13	Ц	17		24	þ	B12
A14	Ц	18		23		B13
A15	Ц	19		22		B14
GND	q	20		21		B15

#### QVSOP TOP VIEW

**INDUSTRIAL TEMPERATURE RANGE** 

# ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

Symbol	Description	Max	Unit
VTERM <sup>(2)</sup>	SupplyVoltage to Ground	-0.5 to +4.6	V
VTERM <sup>(3)</sup>	DC Switch Voltage Vs	-0.5 to +5.5	V
VTERM <sup>(3)</sup>	DC Input Voltage VIN	-0.5 to +5.5	V
VAC	AC Input Voltage (pulse width ≤20ns)	ዻ	V
Ιουτ	DC Output Current (max. sink current/pin)	120	mA
Tstg	Storage Temperature	-65 to +150	°C

NOTES:

 Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

2. Vcc terminals.

3. All terminals except  $\mathsf{Vcc}$  .

### **CAPACITANCE** (TA = $+25^{\circ}$ C, F = 1MHz, VIN = 0V, VOUT = 0V)

Symbol	Parameter <sup>(1)</sup>	Тур.	Max.	Unit
CIN	Control Inputs	3	5	pF
CI/O	Quickswitch Channels (Switch OFF)	4	6	pF
CI/O	Quickswitch Channels (Switch ON)	8	12	pF

NOTE:

1. This parameter is guaranteed but not production tested.

## **PIN DESCRIPTION**

Pin Names	Description
ŌĒx	Output Enable
Ax	Data I/Os
Bx	Data I/Os

## **FUNCTION TABLE**<sup>(1)</sup>

ŌĒx	Function
н	Disconnected
L	Connect (Ax = Bx)

NOTE:

1. H = HIGH Voltage Level

L = LOW Voltage Level

# DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

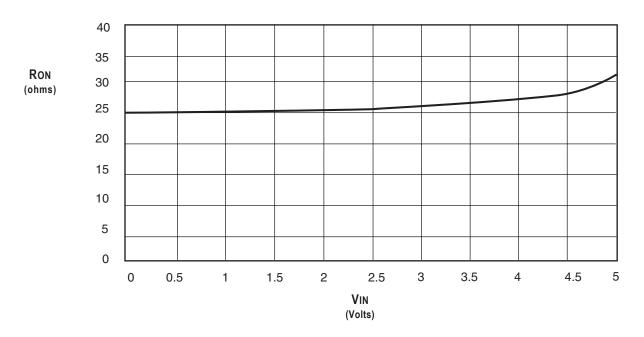
Following Conditions Apply Unless Otherwise Specified: Industrial: TA = -40°C to +85°C, Vcc =  $3.3V \pm 0.3V$ 

Symbol	Parameter	Test C	onditions		Min.	Typ. <sup>(1)</sup>	Max.	Unit
Vih	Input HIGH Voltage	Guaranteed Logic HIGH	Vcc = 2.3V to 2.7	Ϋ́	1.7	—	_	V
		for Control Inputs	Vcc = 2.7V to 3.6	ïV	2	—	_	
Vil	Input LOW Voltage	GuaranteedLogicLOW	Vcc = 2.3V to 2.7	V	—	—	0.7	V
		for Control Inputs	Vcc = 2.7V to 3.6	V	—	—	0.8	]
lin	Input Leakage Current (Control Inputs)	$0V \le VIN \le VCC$		—	—	±1	μA	
loz	Off-State Current (Hi-Z)	$0V \le VOUT \le 5V$ , Switches OFF		—	—	±1	μA	
IOFF	Data Input/Output Power Off Leakage	VIN or VOUT 0V to 5V, VCC = 0V		—	—	±1	μA	
		Vcc = 2.3V	VIN = 0V	Ion = 30mA	18	27	39	
Ron	Switch ON Resistance	Typical at Vcc = 2.5V	VIN = 1.7V	Ion = 15mA	18	28	41	Ω
		Vcc = 3V	VIN = 0V	Ion = 30mA	18	25	38	
			VIN = 2.4V	Ion = 15mA	18	26	40	

NOTE:

1. Typical values are at Vcc = 3.3V and TA = 25°C.

# TYPICAL ON RESISTANCE vs VIN AT Vcc = 3.3V



## **POWER SUPPLY CHARACTERISTICS**

Symbol	Parameter	Test Conditions <sup>(1)</sup>	Min.	Тур.	Max.	Unit
lccq	Quiescent Power Supply Current	Vcc = Max., VIN = GND or Vcc, f = 0	-	4	8	mA
$\Delta$ ICC	Power Supply Current (2,3) per Input HIGH	Vcc = Max., VIN = 3V, f = 0 per Control Input	_		30	μA
ICCD	Dynamic Power Supply Current per Output Enable Control Input <sup>(4)</sup>	Vcc = 3.3V, A and B Pins Open, Control Inputs Toggling @ 50% Duty Cycle	See Typical	ICCD vs Enable	e Frequency (	graph below

NOTES:

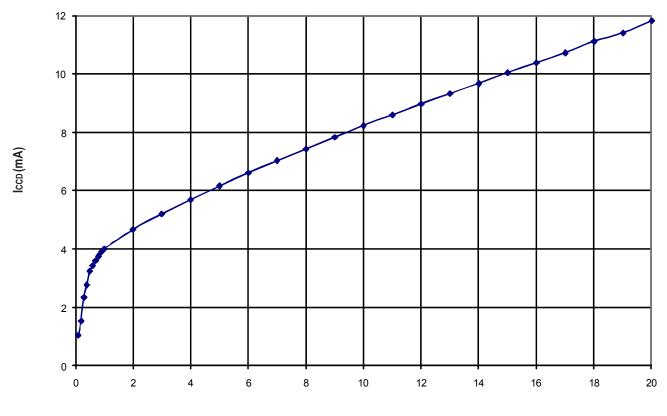
1. For conditions shown as Min. or Max., use the appropriate values specified under DC Electrical Characteristics.

2. Per input driven at the specified level. A and B pins do not contribute to  $\Delta$ lcc.

3. This parameter is guaranteed but not tested.

4. This parameter represents the current required to switch internal capacitance at the specified frequency. The A and B inputs do not contribute to the Dynamic Power Supply Current. This parameter is guaranteed but not production tested.

## TYPICAL ICCD vs ENABLE FREQUENCY CURVE AT VCC = 3.3V



**ENABLE FREQUENCY (MHz)** 

# SWITCHING CHARACTERISTICS OVER OPERATING RANGE

TA = -40°C to +85°C

		$Vcc = 2.5 \pm 0.2V^{(1)}$		Vcc = 3.3		
Symbol	Parameter	Min. <sup>(4)</sup>	Max.	Min. <sup>(4)</sup>	Max.	Unit
tPLH	Data Propagation Delay <sup>(2,3)</sup>	—	0.9	—	1.35	ns
<b>t</b> PHL	Ax to/from Bx					
tPZL	Switch Turn-On Delay	1.5	9	1.5	8	ns
tРZH	OEx to Ax/Bx					
tPLZ	Switch Turn-Off Delay	1.5	7.5	1.5	7.5	ns
tPHZ	OEx to Ax/Bx					
foex	Operating Frequency - Enable <sup>(2,5)</sup>		10		20	MHz

#### NOTES:

1. See Test Conditions under TEST CIRCUITS AND WAVEFORMS.

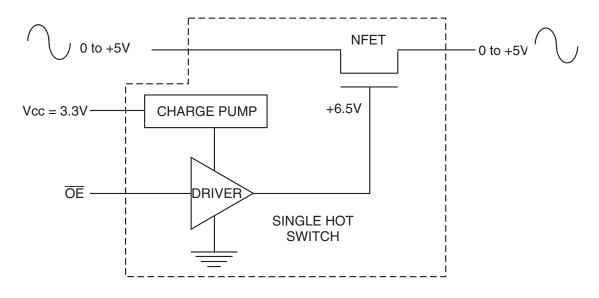
2. This parameter is guaranteed but not production tested.

3. The bus switch contributes no propagation delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 1.35ns at CL = 50pF. Since this time constant is much smaller than the rise and fall times of typical driving signals, it adds very little propagation delay to the system. Propagation delay of the bus switch, when used in a system, is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

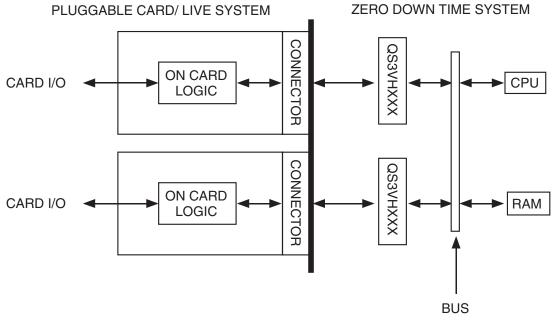
4. Minimums are guaranteed but not production tested.

5. Maximum toggle frequency for  $\overline{\text{OEx}}$  control input (pass voltage > Vcc, Vin = 5V, RLOAD  $\geq$  1M $\Omega$ , no CLOAD).

## SOME APPLICATIONS FOR HOTSWITCH PRODUCTS



Rail-to-Rail Switching

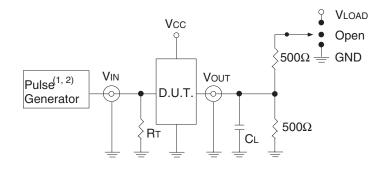


Hot-Swapping

# TEST CIRCUITS AND WAVEFORMS

## **TEST CONDITIONS**

Symbol	$Vcc^{(1)}= 3.3V \pm 0.3V$	$Vcc^{(2)} = 2.5V \pm 0.2V$	Unit
VLOAD	6	2 x Vcc	V
Vih	3	Vcc	V
Vт	1.5	Vcc/2	V
VLZ	300	150	mV
Vнz	300	150	mV
CL	50	30	pF



Test Circuits for All Outputs

#### **DEFINITIONS:**

CL = Load capacitance: includes jig and probe capacitance.

RT = Termination resistance: should be equal to ZOUT of the Pulse Generator.

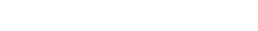
### NOTES:

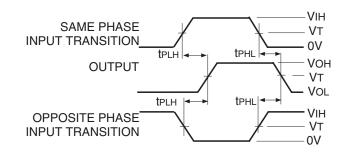
1. Pulse Generator for All Pulses: Rate  $\leq$  10MHz; tF  $\leq$  2.5ns; tR  $\leq$  2.5ns.

2. Pulse Generator for All Pulses: Rate  $\leq$  10MHz; tF  $\leq$  2ns; tR  $\leq$  2ns.

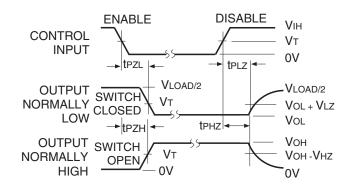
# **SWITCH POSITION**

Test	Switch
tplz/tpzl	Vload
tрнz/tpzн	GND
tPD	Open





### Propagation Delay



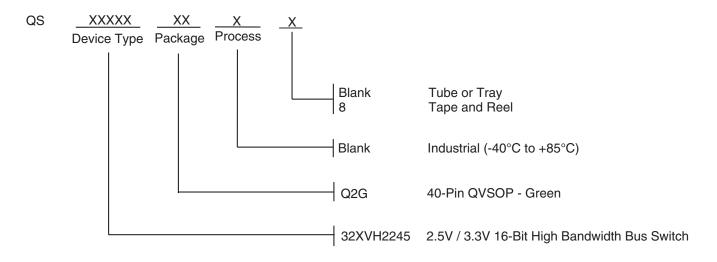
#### NOTE:

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.

**Enable and Disable Times** 

INDUSTRIALTEMPERATURERANGE

### **ORDERING INFORMATION**



## **Datasheet Document History**

09/01/08	Pg. 4, 8	Revise ICCQ Typ. and Max. Remove non green package version and updated the ordering
		information by removing the "IDT" notation.
06/14/11	Pg. 8	Updated ordering information to include tube or tray and tape & reel.

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